

# Technical Data Sheet

P-THERM®

# PS-2641

### **Product Description:**

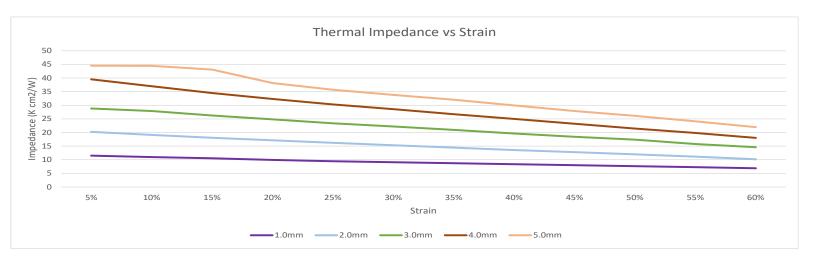
P-THERM® PS-2641 is a silicone based thermally conductive gap filler with an embedded fiberglass support and 125 micron removable polyester carrier.

## **Construction / Properties:**

|            | Property                              | Value           |      |      | Test Method   |  |
|------------|---------------------------------------|-----------------|------|------|---------------|--|
| General    | Color                                 | Gray            |      |      | Visual        |  |
|            | Thickness Range                       | 0.5 mm - 5.0 mm |      |      | ASTM D374     |  |
|            | Reinforcement Carrier Type            | Fiberglass      |      |      |               |  |
|            | Density (g/cc)                        | 1.82            |      |      | ASTM D792     |  |
|            | Heat Capacity (J/g K) @ 50 C          | 0.97            |      |      | ASTM E1269    |  |
|            | Hardness (Shore 00)                   | 22              |      |      | ASTM D2240    |  |
|            | Total Mass Loss (@ 125 C/24 hrs)      | 0.15%           |      |      | ASTM E595**   |  |
|            | Flammability Rating                   | V-0             |      |      | UL 94         |  |
|            | Continuous Use Conditions             | -60 - 200 C     |      |      | QSP-754       |  |
| Electrical | Property                              | Value           |      |      | Test Method   |  |
|            | Dielectric Breakdown Strength (kV/mm) | 12.00           |      |      | ASTM D149     |  |
|            | Volume Resistivity (ohm-cm)           | I.0E+09         |      |      | ASTM D257     |  |
|            | Property                              | Value           |      |      | Test Method   |  |
| Thermal    | Thermal Conductivity                  | I W/m K         |      |      | ASTM D5470*   |  |
|            | Thermal Performance vs. Strain        |                 |      |      |               |  |
|            | Deflection (% Strain)                 | 10              | 20   | 30   | ASTM D5470*** |  |
|            | Thermal Impedance (K cm²/W) @ Imm     | 10.99           | 9.94 | 9.08 |               |  |

<sup>\*</sup> Thermal conductivity tested at 20% strain.

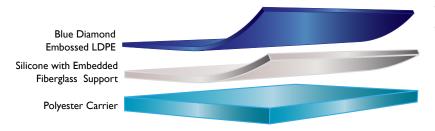
<sup>\*\*\*</sup> Values tested include interfacial thermal resistance: Application performance is directly related to surface roughness, flatness and pressure applied.



<sup>\*\*</sup> Tested at atmospheric pressure

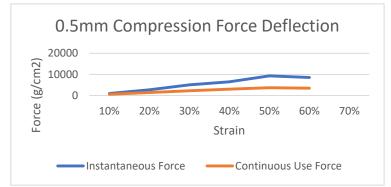
#### Features:

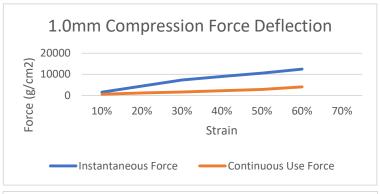
- Good Thermal Conductivity
- Excellent Compression Characteristics
- Excellent Wet-Out
- Superb Flexibility
- Excellent Converting Properties
- RoHS and HF Compliant

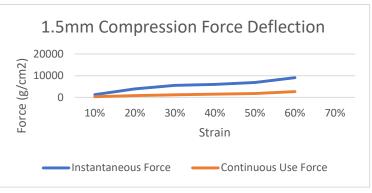


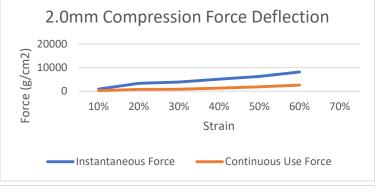
#### **Applications:**

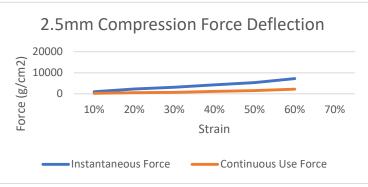
- LED Lighting
- Battery Components
- Infotainment Modules
- Smartphones
- Tablets
- Computers
- Digital Personal Assistants
- Automotive Lighting

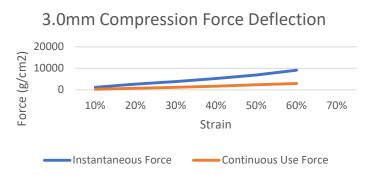












Specific tests should be performed by the end user to determine the product stability for the particular application.

#### For Additional Information:

E-mail: sales@polymerscience.com
Toll Free: +1 888.533.7004

Web: www.polymerscience.com

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